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Global Metal-Bonded Grinding Wheels for SiC Wafers Market Growth 2026-2032

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Abstracts

The global Metal-Bonded Grinding Wheels for SiC Wafers market size is predicted to grow from US$ 144 million in 2025 to US$ 394 million in 2032; it is expected to grow at a CAGR of 15.8% from 2026 to 2032.

Metal-Bonded Grinding Wheels for SiC Wafers are ultra-precision grinding tools specifically designed for thinning and planarization of silicon carbide wafers. Using diamond as the abrasive material and metal bonds for efficient abrasive retention, these wheels enable stable grinding of high-hardness silicon carbide materials at high rotational speeds, achieving nanoscale surface accuracy and controlled subsurface damage. They are primarily used in the manufacturing of silicon carbide power devices for applications in new energy vehicles, industrial motors, and photovoltaic inverters. The global market for metal-bonded grinding wheels for SiC wafers is approximately $133.27 million USD in 2024, with an annual sales volume of about 219,200 units. The projected CAGR for the next five years is about 15.2%. The market price is $608 per unit, single-line annual production capacity ranges from 12,000 to 18,000 units, and industry gross margins are generally between 45% and 58%.

United States market for Metal-Bonded Grinding Wheels for SiC Wafers is estimated to increase from US$ million in 2025 to US$ million by 2032, at a CAGR of % from 2026 through 2032.

China market for Metal-Bonded Grinding Wheels for SiC Wafers is estimated to increase from US$ million in 2025 to US$ million by 2032, at a CAGR of % from 2026 through 2032.

Europe market for Metal-Bonded Grinding Wheels for SiC Wafers is estimated to

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increase from US$ million in 2025 to US$ million by 2032, at a CAGR of % from 2026 through 2032.

Global key Metal-Bonded Grinding Wheels for SiC Wafers players cover Disco, Asahi Diamond Industrial, Meister Abrasives, Moresuperhard, Tokyo Diamond Tools, etc. In terms of revenue, the global two largest companies occupied for a share nearly % in 2025.

Report Scope

LP Information, Inc. (LPI) ' newest research report, the “Metal-Bonded Grinding Wheels for SiC Wafers Industry Forecast” looks at past sales and reviews total world Metal-Bonded Grinding Wheels for SiC Wafers sales in 2025, providing a comprehensive analysis by region and market sector of projected Metal-Bonded Grinding Wheels for SiC Wafers sales for 2026 through 2032. With Metal-Bonded Grinding Wheels for SiC Wafers sales broken down by region, market sector and sub-sector, this report provides a detailed analysis in US$ millions of the world Metal-Bonded Grinding Wheels for SiC Wafers industry.

This Insight Report provides a comprehensive analysis of the global Metal-Bonded Grinding Wheels for SiC Wafers landscape and highlights key trends related to product segmentation, company formation, revenue, and market share, latest development, and M&A activity. This report also analyzes the strategies of leading global companies with a focus on Metal-Bonded Grinding Wheels for SiC Wafers portfolios and capabilities, market entry strategies, market positions, and geographic footprints, to better understand these firms’ unique position in an accelerating global Metal-Bonded Grinding Wheels for SiC Wafers market.

This Insight Report evaluates the key market trends, drivers, and affecting factors shaping the global outlook for Metal-Bonded Grinding Wheels for SiC Wafers and breaks down the forecast by Type, by Application, geography, and market size to highlight emerging pockets of opportunity. With a transparent methodology based on hundreds of bottom-up qualitative and quantitative market inputs, this study forecast offers a highly nuanced view of the current state and future trajectory in the global Metal-Bonded Grinding Wheels for SiC Wafers.

This report presents a comprehensive overview, market shares, and growth opportunities of Metal-Bonded Grinding Wheels for SiC Wafers market by product type, application, key manufacturers and key regions and countries.

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Market Segmentation

Segmentation by Type:

Natural Abrasives

Synthetic Abrasives

Segmentation by Grinding Accuracy:

Standard Grade

Ultra-Precision Grade

Segmentation by Application:

Precision Optics

Semiconductor

Others

This report also splits the market by region:

Americas

United States

Canada

Mexico

Brazil

APAC

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- China
- Japan
- Korea
- Southeast Asia
- India
- Australia

Europe

- Germany
- France
- UK
- Italy
- Russia

Middle East & Africa

- Egypt
- South Africa
- Israel
- Turkey
- GCC Countries

The below companies that are profiled have been selected based on inputs gathered

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from primary experts and analysing the company's coverage, product portfolio, its market penetration.

Disco

Asahi Diamond Industrial

Meister Abrasives

Moresuperhard

Tokyo Diamond Tools

A.L.M.T. Corp (Sumitomo Electric)

Tokyo Seimitsu

Saint-Gobain

EHWA DIAMOND

OKAMOTO MACHINE TOOL WORKS

Zhengzhou Qisheng Precision Manufacturing

Carbo Tzujan Industry

KINIK COMPANY

China National Machinery Industry Corporation

Henan Keen Super-hard Material Technology

Dongguan Zhongwei Lihe Semiconductor Technology

Zhengzhou Abrasive and Grinding Tool Research Institute

NanJing Sanchao Advanced Materials

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Suzhou Sail Science & Technology

Key Questions Addressed in this Report

What is the 10-year outlook for the global Metal-Bonded Grinding Wheels for SiC Wafers market?

What factors are driving Metal-Bonded Grinding Wheels for SiC Wafers market growth, globally and by region?

Which technologies are poised for the fastest growth by market and region?

How do Metal-Bonded Grinding Wheels for SiC Wafers market opportunities vary by end market size?

How does Metal-Bonded Grinding Wheels for SiC Wafers break out by Type, by Application?

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